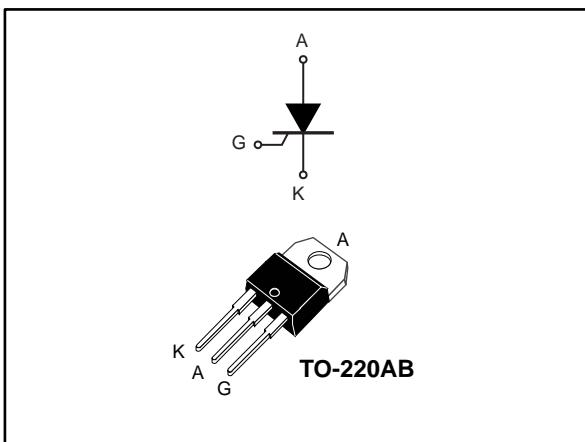


High temperature 16 A SCRs

Datasheet - production data



Features

- High junction temperature: $T_j = 150^\circ\text{C}$
- Gate triggering current $I_{GT} = 6 \text{ mA}$
- High noise immunity $dV/dt = 200 \text{ V}/\mu\text{s}$ up to 150°C
- Blocking voltage $V_{DRM}/V_{RRM} = 600 \text{ V}$
- High turn-on current rise $di/dt: 100 \text{ A}/\mu\text{s}$
- ECOPACK®2 compliant component

Applications

- Motorbikes voltage regulator circuits
- Inrush current limiting circuits
- Motor control circuits and starters
- Light dimmers
- Solid state relays

Description

Designed with high immunity switching to external surges, the device offers robust switching up to its 150°C maximum T_j .

The combination of noise immunity and low gate triggering current allows to design strong and compact control circuit.

Table 1: Device summary

| Order code | Package | V_{DRM}/V_{RRM} | I_{GT} |
|------------|----------|-------------------|----------|
| TN1605H-6T | TO-220AB | 600 | 6 mA |

1 Characteristics

Table 2: Absolute maximum ratings (limiting values, $T_j = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | | | Value | Unit |
|---------------------|---|--|---------------------------|-------------|------------------------|
| $I_{T(\text{RMS})}$ | RMS on-state current (180° conduction angle) | | $T_c = 133^\circ\text{C}$ | 16 | A |
| $I_{T(\text{AV})}$ | Average on-state current (180° conduction angle) | | $T_c = 133^\circ\text{C}$ | 10 | A |
| | | | $T_c = 138^\circ\text{C}$ | 8 | |
| | | | $T_c = 142^\circ\text{C}$ | 6 | |
| I_{TSM} | Non repetitive surge peak on-state current | $t_p = 8.3\text{ ms}$ | T_j initial = 25 °C | 153 | A |
| | | $t_p = 10\text{ ms}$ | | 140 | |
| I^2t | I^2t value for fusing | $t_p = 10\text{ ms}$ | | 98 | A^2s |
| dI/dt | Critical rate of rise of on-state current | $I_G = 2 \times I_{GT}, t_r \leq 100\text{ ns},$ | $f = 60\text{ Hz}$ | 100 | $\text{A}/\mu\text{s}$ |
| V_{DRM}/V_{RRM} | Repetitive peak off-state voltage | | $T_j = 150^\circ\text{C}$ | 600 | V |
| V_{DSM}/V_{RSM} | Non repetitive surge peak off-state voltage | $t_p = 10\text{ ms}$ | | 700 | V |
| $P_{G(\text{AV})}$ | Average gate power dissipation | | $T_j = 150^\circ\text{C}$ | 1 | W |
| V_{RGM} | Maximum peak reverse gate voltage | | | 5 | V |
| I_{GM} | Peak gate current | $t_p = 20\text{ }\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | 4 | A |
| P_{GM} | Peak gate power dissipation | $t_p = 20\text{ }\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | 40 | W |
| $P_{G(\text{AV})}$ | Average gate power dissipation | | $T_j = 150^\circ\text{C}$ | 1 | W |
| T_{stg} | Storage junction temperature range | | | -40 to +150 | °C |
| T_j | Operating junction temperature range | | | -40 to +150 | °C |
| T_L | Maximum lead temperature for soldering during 10 s | | | 260 | °C |

Table 3: Dynamic characteristics

| Symbol | Parameter | T_j | | Value | Unit |
|----------|--|--------|------|-------|------------------------|
| I_{GT} | $V_D = 12\text{ V}, R_L = 33\text{ }\Omega$ | 25 °C | Min. | 3.5 | mA |
| | | | Typ. | 4.5 | |
| | | | Max. | 6 | |
| | | | Max. | 1.3 | V |
| V_{GD} | $V_D = 600\text{ V}, R_L = 3.3\text{ k}\Omega$ | 150 °C | Min. | 0.15 | V |
| I_L | $I_G = 1.2 \times I_{GT}$ | 25 °C | Max. | 40 | mA |
| I_H | $I_T = 500\text{ mA, gate open}$ | | Max. | 20 | |
| dV/dt | $V_D = 402\text{ V, gate open}$ | 150 °C | Min. | 200 | $\text{V}/\mu\text{s}$ |
| t_{gt} | $I_{TM} = 32\text{ A}, V_D = 402\text{ V}, I_G = 12\text{ mA}, (dI_G/dt)_{\text{max}} = 0.2\text{ A}/\mu\text{s}$ | 25 °C | Typ. | 1.9 | μs |
| t_q | $I_{TM} = 32\text{ A}, V_D = 402\text{ V}, (dI/dt)_{\text{off}} = 30\text{ A}/\mu\text{s}, V_R = 25\text{ V}, dV_D/dt = 20\text{ V}/\mu\text{s}$ | 150 °C | Typ. | 70 | μs |

Table 4: Static electrical characteristics

| Symbol | Test Conditions | T_j | | Value | Unit |
|------------------------------------|---|----------------------|------|--------------|-------------|
| V _{TM} | I _{TM} = 32 A, t _p = 380 µs | 25 °C | Max. | 1.6 | V |
| V _{TO} | Threshold on-state voltage | 150 °C | Max. | 0.82 | V |
| R _D | Dynamic resistance | 150 °C | Max. | 25 | mΩ |
| I _{DRM} /I _{RRM} | V _{DRM} = V _{RRM} | 25 °C | Max. | 5 | µA |
| | | 125 °C | | 1.5 | mA |
| | | 150 °C | | 3.1 | |

Table 5: Thermal resistance

| Symbol | Parameter | Value | Unit |
|----------------------|--------------------------|--------------|-------------|
| R _{th(j-c)} | Junction to case (DC) | 1.1 | °C/W |
| R _{th(j-a)} | Junction to ambient (DC) | 60 | |

1.1 Characteristics (curves)

Figure 1: Maximum average power dissipation versus average on-state current

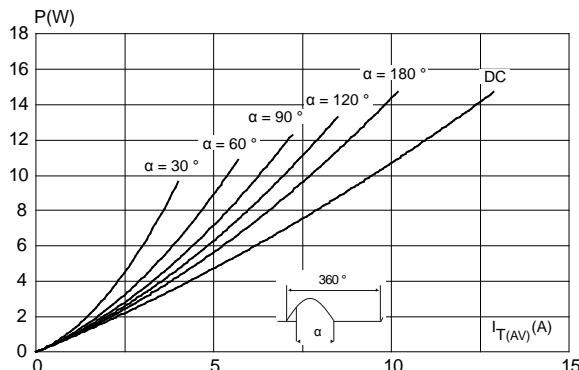


Figure 2: Average and DC on-state current versus case temperature

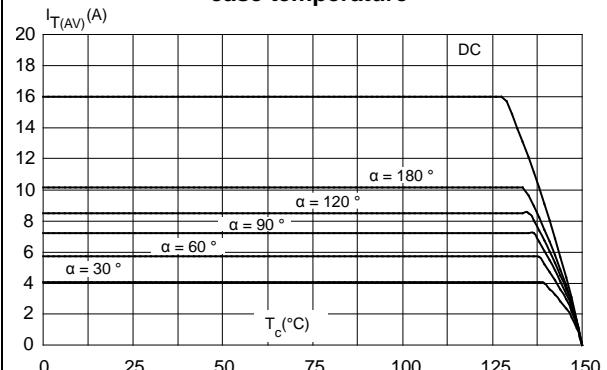


Figure 3: Average and DC on-state current versus ambient temperature

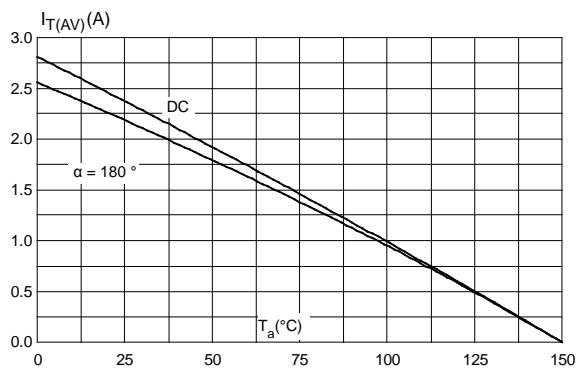


Figure 4: Relative variation of thermal impedance versus pulse duration

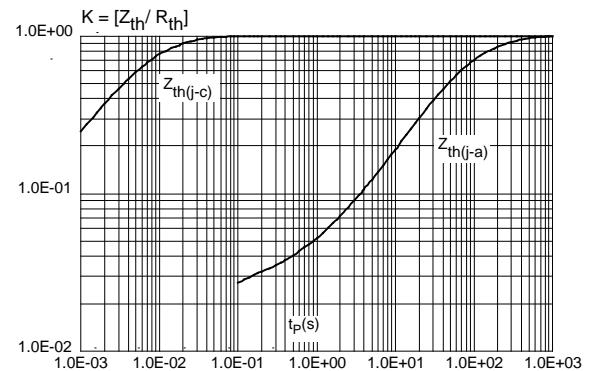


Figure 5: Relative variation of gate trigger current and gate voltage versus junction temperature (typical values)

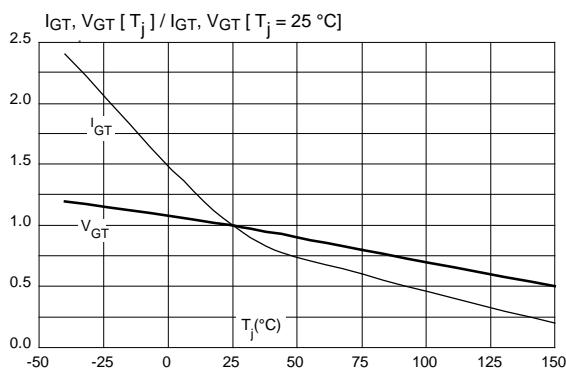


Figure 6: Relative variation of holding and latching current versus junction temperature (typical values)

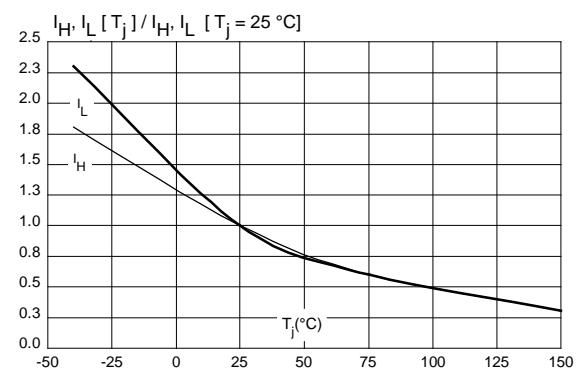


Figure 7: Relative variation of static dV/dt immunity versus junction temperature (typical values)

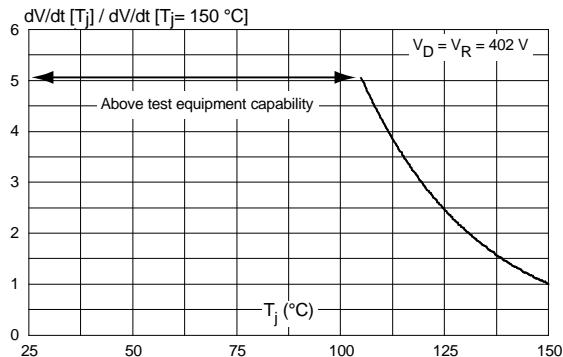


Figure 8: Surge peak on-state current versus number of cycles

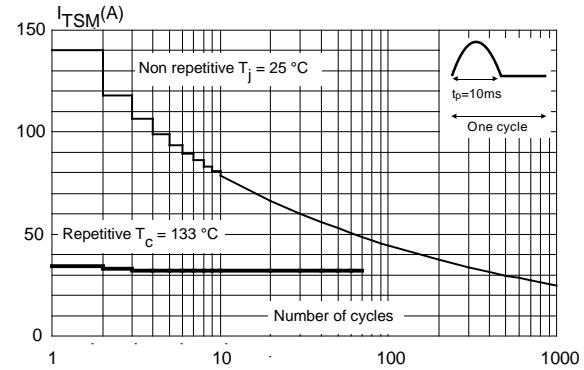


Figure 9: Non repetitive surge peak on-state current versus sinusoidal pulse width ($t_p < 10$ ms).

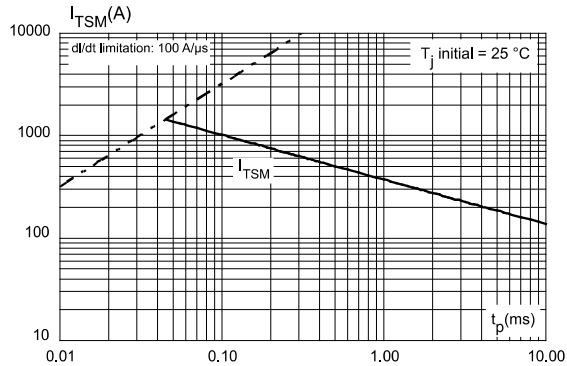


Figure 10: On-state characteristics (maximum values)

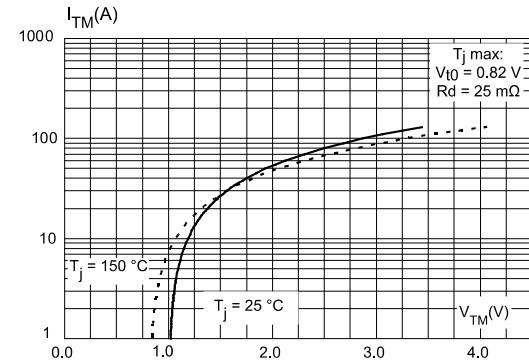
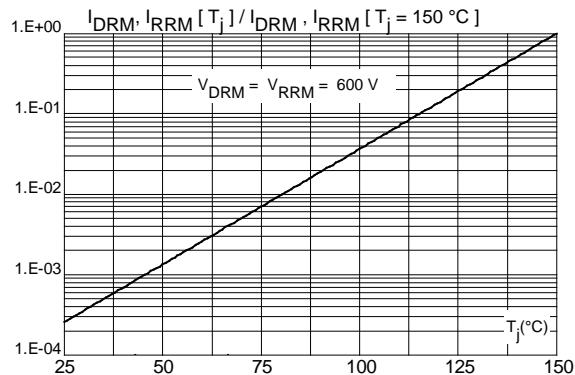


Figure 11: Relative variation of leakage current versus junction temperature ($t_p < 10$ ms)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

- Epoxy meets UL 94,V0
- Lead-free package

2.1 TO-220AB (NIns. and Ins.) package information

Figure 12: TO-220AB (NIns. & Ins.) package outline

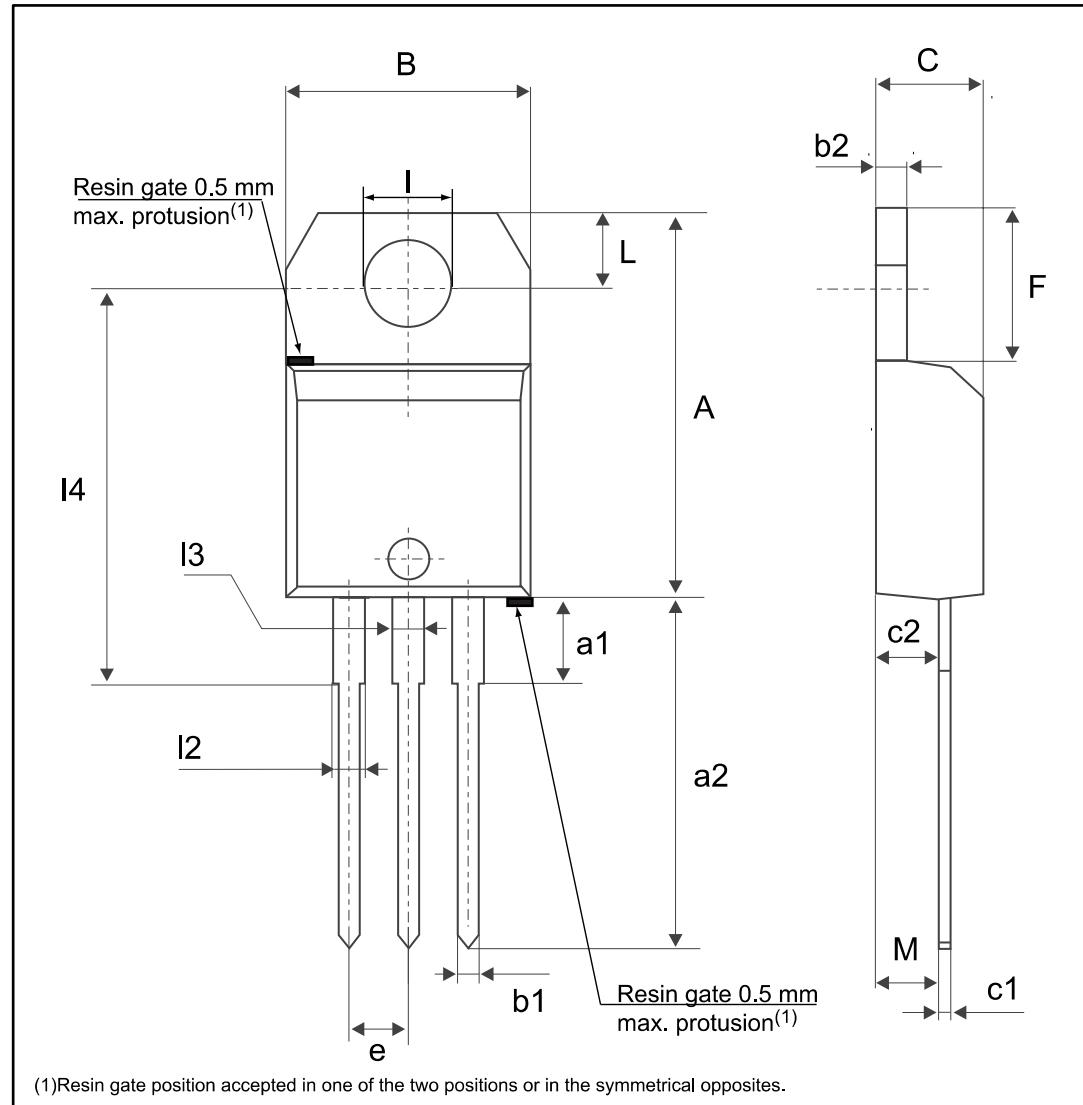


Table 6: TO-220AB (NIns. & Ins.) package mechanical data

| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|-----------------------|--------|--------|
| | Millimeters | | | Inches ⁽¹⁾ | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 15.20 | | 15.90 | 0.5984 | | 0.6260 |
| a1 | | 3.75 | | | 0.1476 | |
| a2 | 13.00 | | 14.00 | 0.5118 | | 0.5512 |
| B | 10.00 | | 10.40 | 0.3937 | | 0.4094 |
| b1 | 0.61 | | 0.88 | 0.0240 | | 0.0346 |
| b2 | 1.23 | | 1.32 | 0.0484 | | 0.0520 |
| C | 4.40 | | 4.60 | 0.1732 | | 0.1811 |
| c1 | 0.49 | | 0.70 | 0.0193 | | 0.0276 |
| c2 | 2.40 | | 2.72 | 0.0945 | | 0.1071 |
| e | 2.40 | | 2.70 | 0.0945 | | 0.1063 |
| F | 6.20 | | 6.60 | 0.2441 | | 0.2598 |
| I | 3.73 | | 3.88 | 0.1469 | | 0.1528 |
| L | 2.65 | | 2.95 | 0.1043 | | 0.1161 |
| I2 | 1.14 | | 1.70 | 0.0449 | | 0.0669 |
| I3 | 1.14 | | 1.70 | 0.0449 | | 0.0669 |
| I4 | 15.80 | 16.40 | 16.80 | 0.6220 | 0.6457 | 0.6614 |
| M | | 2.6 | | | 0.1024 | |

Notes:

(1)Inch dimensions are for reference only.

3 Ordering information

Figure 13: Ordering information scheme

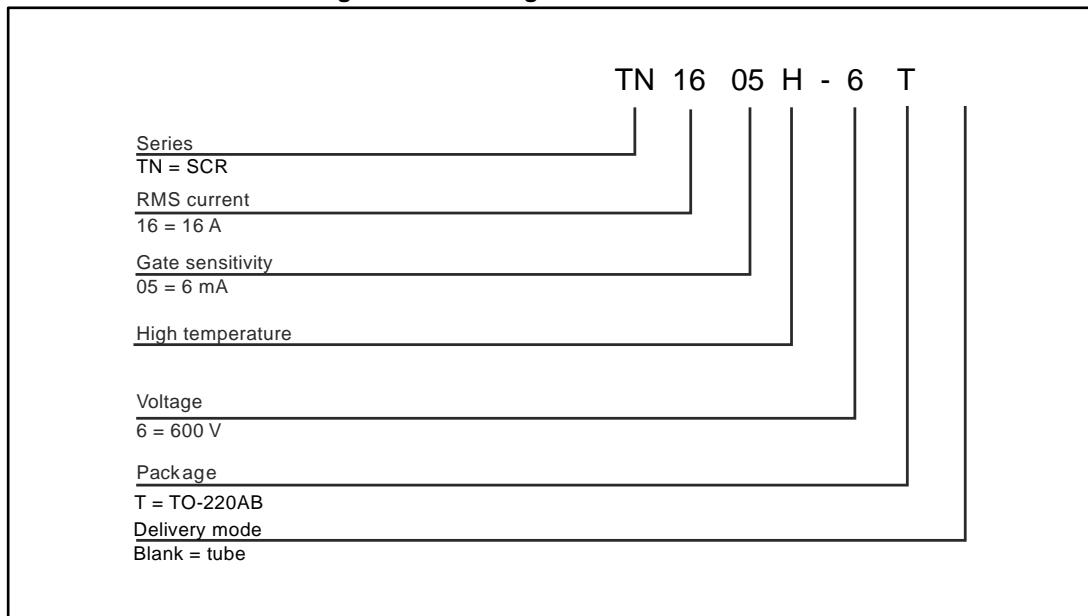


Table 7: Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|------------|----------|----------|--------|-----------|---------------|
| TN1605H-6T | TN1605H6 | TO-220AB | 2.3 g | 50 | Tube |

4 Revision history

Table 8: Document revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 19-May-2017 | 1 | Initial release. |

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